74HC193; 74HCT193

Presettable synchronous 4-bit binary up/down counter

Rev. 8 — 14 March 2024 Product data sheet

1. General description

The 74HC193; 74HCT193 is a 4-bit synchronous binary up/down counter. Separate up/down clocks, CPU and CPD respectively, simplify operation. The outputs change state synchronously with the LOW-to-HIGH transition of either clock input. If the CPU clock is pulsed while CPD is held HIGH, the device will count up. If the CPD clock is pulsed while CPU is held HIGH, the device will count down. Only one clock input can be held HIGH at any time to guarantee predictable behavior. The device can be cleared at any time by the asynchronous master reset input (MR); it may also be loaded in parallel by activating the asynchronous parallel load input (PL). The terminal count up (TCU) and terminal count down (TCD) outputs are normally HIGH. When the circuit has reached the maximum count state of 15, the next HIGH-to-LOW transition of CPU will cause TCU to go LOW. TCU will stay LOW until CPU goes HIGH again, duplicating the count up clock. Likewise, the TCD output will go LOW when the circuit is in the zero state and the CPD goes LOW. The terminal count outputs can be used as the clock input signals to the next higher order circuit in a multistage counter, since they duplicate the clock waveforms. Multistage counters will not be fully synchronous, since there is a slight delay time difference added for each stage that is added. The counter may be preset by the asynchronous parallel load capability of the circuit. Information present on the parallel data inputs (D0 to D3) is loaded into the counter and appears on the outputs (Q0 to Q3) regardless of the conditions of the clock inputs when the parallel load (\overline{PL}) input is LOW. A HIGH level on the master reset (MR) input will disable the parallel load gates, override both clock inputs and set all outputs (Q0 to Q3) LOW. If one of the clock inputs is LOW during and after a reset or load operation, the next LOW-to-HIGH transition of that clock will be interpreted as a legitimate signal and will be counted. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

- Wide supply voltage range from 2.0 to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Input levels:
 - For 74HC193: CMOS level
 - For 74HCT193: TTL level
- Synchronous reversible 4-bit binary counting
- Asynchronous parallel load
- Asynchronous reset
- Expandable without external logic
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

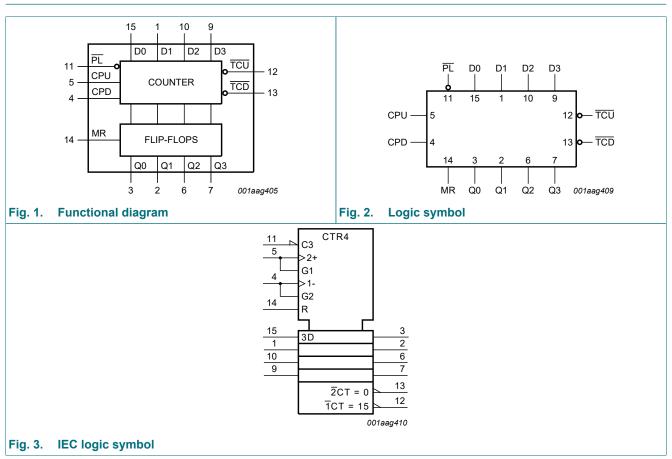


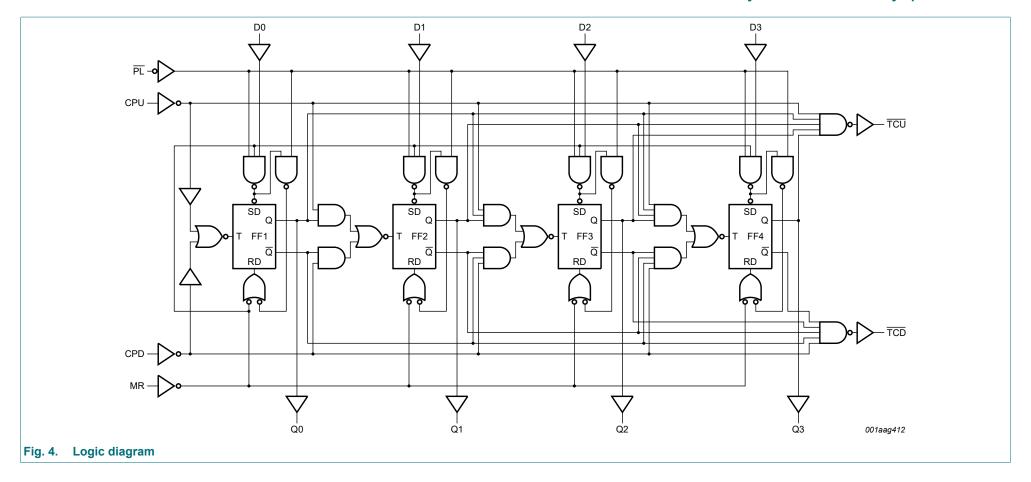
3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC193D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1
74HCT193D			body width 3.9 mm	
74HC193PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1
74HCT193PW			body width 4.4 mm	

4. Functional diagram

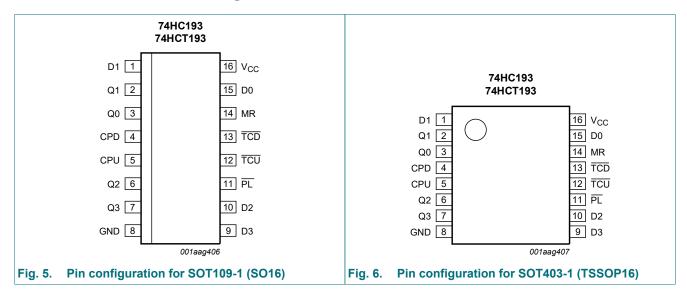




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5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
D0, D1, D2, D3	15, 1, 10, 9	data input
Q0, Q1, Q2, Q3	3, 2, 6, 7	flip-flop output
CPD	4	count down clock input; LOW-to-HIGH, edge triggered
CPU	5	count up clock input; LOW-to-HIGH, edge triggered
GND	8	ground (0 V)
PL	11	asynchronous parallel load input (active LOW)
TCU	12	terminal count up (carry) output (active LOW)
TCD	13	terminal count down (borrow) output (active LOW)
MR	14	asynchronous master reset input (active HIGH)
V _{CC}	16	supply voltage

6. Functional description

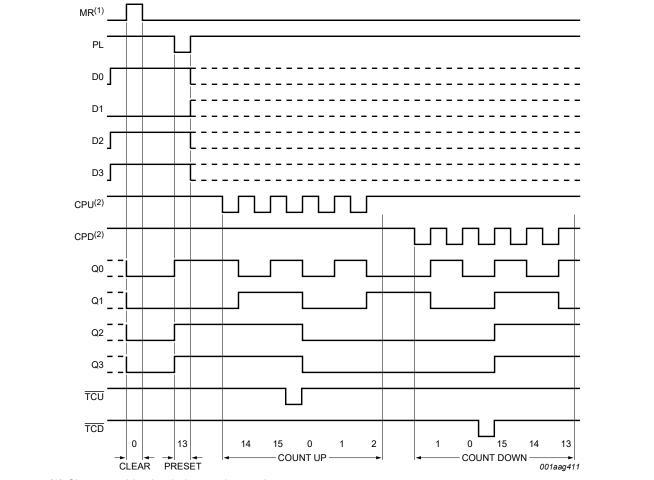
Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ \uparrow = LOW-to-HIGH \ clock \ transition.$

Operating mode	Input	s							Outp	uts				
	MR	PL	CPU	CPD	D0	D1	D2	D3	Q0	Q1	Q2	Q3	TCU	TCD
Reset (clear)	Н	Х	Х	L	Х	Х	Х	Х	L	L	L	L	Н	L
	Н	Х	Х	Н	Х	Х	Х	Х	L	L	L	L	Н	Н
Parallel load	L	L	Х	L	L	L	L	L	L	L	L	L	Н	L
	L	L	Х	Н	L	L	L	L	L	L	L	L	Н	Н
	L	L	L	Х	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
	L	L	Н	Х	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
Count up	L	Н	1	Н	Х	Х	Х	Х	count	up			H [1]	Н
Count down	L	Н	Н	1	Х	Χ	Х	Х	count	down			Н	H [2]

^[1] $\overline{TCU} = CPU$ at terminal count up (HHHH)

^[2] TCD = CPD at terminal count down (LLLL).



- (1) Clear overrides load, data and count inputs.
- (2) When counting up, the count down clock input (CPD) must be HIGH, when counting down the count up clock input (CPU) must be HIGH.

Sequence:

Clear (reset outputs to zero);

Load (preset) to binary thirteen;

Count up to fourteen, fifteen, terminal count up, zero, one and two;

Count down to one, zero, terminal count down, fifteen, fourteen and thirteen.

Fig. 7. Typical clear, load and count sequence

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
I _{OK}	output clamping current	V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V	[1]	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-	-50	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation		[2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC193	3	7	74HCT19	3	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

^[2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

9. Static characteristics

Table 6. Static characteristics type 74HC193

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					-
V _{IH}	HIGH-level input	V _{CC} = 2.0 V	1.5	1.2	-	V
	voltage	V _{CC} = 4.5 V	3.15	2.4	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	V
V _{IL}	LOW-level input	V _{CC} = 2.0 V	-	0.8	0.5	V
	voltage	V _{CC} = 4.5 V	-	2.1	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	V
V _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL}	-	-	-	
	voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	V
		I _O = -5.2 mA; V _{CC} = 6.0 V	5.48	5.81	-	V
V _{OL}	LOW-level output	V _I = V _{IH} or V _{IL}				
	voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	μA
I _{CC}	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	μA
C _i	input capacitance		-	3.5	-	pF

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Γ _{amb} = -40	0 °C to +85 °C					
/ _{IH}	HIGH-level input	V _{CC} = 2.0 V	1.5	-	-	V
	voltage	V _{CC} = 4.5 V	3.15	-	-	V
		V _{CC} = 6.0 V	4.2	-	-	V
/ _{IL}	LOW-level input	V _{CC} = 2.0 V	-	-	0.5	V
	voltage	V _{CC} = 4.5 V	-	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.8	V
/ _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL}				
	voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	-	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	-	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	-	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.84	-	-	V
		I _O = -5.2 mA; V _{CC} = 6.0 V	5.34	-	-	V
√ _{OL}	LOW-level output	$V_I = V_{IH}$ or V_{IL}				
	voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	-	0.33	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	-	0.33	V
ı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μA
lcc	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	80	μA
T _{amb} = -40	0 °C to +125 °C		'	•	'	'
V _{IH}	HIGH-level input	V _{CC} = 2.0 V	1.5	-	-	V
	voltage	V _{CC} = 4.5 V	3.15	-	-	V
		V _{CC} = 6.0 V	4.2	-	-	V
V _{IL}	LOW-level input	V _{CC} = 2.0 V	-	-	0.5	V
	voltage	V _{CC} = 4.5 V	-	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.8	V
V _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL}				
	voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	-	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	-	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	-	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.7	-	-	V
		I _O = -5.2 mA; V _{CC} = 6.0 V	5.2	-	-	V
V _{OL}	LOW-level output	$V_I = V_{IH}$ or V_{IL}				
	voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μA
I _{CC}	supply current	$V_1 = V_{CC}$ or GND; $I_0 = 0$ A; $V_{CC} = 6.0$ V	-	-	160	μA

Table 7. Static characteristics type 74HCT193

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C	-			'	
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	V
V _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$				
	voltage	I _O = -20 μA	4.4	4.5	-	V
		I _O = -4.0 mA	3.98	4.32	-	V
V _{OL}	LOW-level output	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$				
	voltage	I _O = 20 μA	-	0	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	V
lı .	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	μA
СС	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC}$ - 2.1 V; other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V				
		pin Dn	-	35	126	μΑ
		pins CPU, CPD	-	140	504	μΑ
		pin PL	-	65	234	μΑ
		pin MR	-	105	378	μA
C _i	input capacitance		-	3.5	-	pF
T _{amb} = -40	°C to +85 °C		1		'	
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	-	0.8	V
V _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$				
	voltage	I _O = -20 μA	4.4	-	-	V
		I _O = -4.0 mA	3.84	-	-	V
√ _{OL}	LOW-level output	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V				
	voltage	Ι _Ο = 20 μΑ	-	-	0.1	V
		I _O = 4.0 mA	-	-	0.33	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μΑ
lcc	supply current	$V_1 = V_{CC}$ or GND; $I_0 = 0$ A; $V_{CC} = 5.5$ V	-	-	80	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC}$ - 2.1 V; other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V				
		pin Dn	-	-	157.5	μΑ
		pins CPU, CPD	-	-	630	μΑ
		pin PL	-	-	292.5	μΑ
		pin MR	-	-	472.5	μA

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -40	°C to +125 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	-	0.8	V
V _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$				
	voltage	I _O = -20 μA	4.4	-	-	V
		I _O = -4.0 mA	3.7	-	-	V
V _{OL}	LOW-level output	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$				
	voltage	I _O = 20 μA	-	-	0.1	V
		I _O = 4.0 mA	-	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μΑ
I _{CC}	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 5.5$ V	-	-	160	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC}$ - 2.1 V; other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V				
		pin Dn	-	-	171.5	μΑ
		pins CPU, CPD	-	-	686	μΑ
		pin PL	-	-	318.5	μΑ
		pin MR	-	-	514.5	μA

10. Dynamic characteristics

Symbol	Parameter	acteristics type 74HC193 Conditions				-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	-
pd	propagation	CPU, CPD to Qn; see Fig. 8 [1]	-							
•	delay	V _{CC} = 2.0 V	-	63	215	-	270	-	325	ns
		V _{CC} = 4.5 V	-	23	43	-	54	-	65	ns
		V _{CC} = 6.0 V	-	18	37	-	46	-	55	ns
		CPU to TCU; see Fig. 9								
		V _{CC} = 2.0 V	-	39	125	-	155	-	190	ns
		V _{CC} = 4.5 V	-	14	25	-	31	-	38	ns
		V _{CC} = 6.0 V	-	11	21	-	26	-	32	ns
		CPD to TCD; see Fig. 9								
		V _{CC} = 2.0 V	-	39	125	-	155	-	190	ns
		V _{CC} = 4.5 V	_	14	25	-	31	-	38	ns
		V _{CC} = 6.0 V	_	11	21	-	26	-	32	ns
		PL to Qn; see Fig. 10								
		V _{CC} = 2.0 V	_	69	220	-	275	-	330	ns
		V _{CC} = 4.5 V	_	25	44	-	55	-	66	ns
		V _{CC} = 6.0 V	_	20	37	-	47	-	56	ns
		MR to Qn; see Fig. 11								
		V _{CC} = 2.0 V	_	58	200	-	250	-	300	ns
		V _{CC} = 4.5 V	_	21	40	-	50	-	60	ns
		V _{CC} = 6.0 V	_	17	34		43	-	51	ns
		Dn to Qn; see Fig. 10								
		V _{CC} = 2.0 V	_	69	210	-	265	-	315	ns
		V _{CC} = 4.5 V	-	25	42	-	53	-	63	ns
		V _{CC} = 6.0 V	_	20	36	-	45	-	54	ns
		PL to TCU, PL to TCD; see Fig. 13								
		V _{CC} = 2.0 V	_	80	290	_	365	-	435	nc
			-	29	58	-	73		87	ns
		V _{CC} = 4.5 V V _{CC} = 6.0 V	-	23	49	-	62	-	74	ns
		MR to TCU, MR to TCD; see Fig. 13	-	23	48	-	02	-	74	ns
		V _{CC} = 2.0 V	_	74	285	_	355	_	430	ns
		V _{CC} = 4.5 V	_	27	57	_	71	_	86	ns
		$V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$	-	22	48	-	60	-	73	ns
		Dn to TCU, Dn to TCD; see Fig. 13	-		70	_	- 50	-	7.5	113
		V _{CC} = 2.0 V	_	80	290	-	365	_	435	ns
		V _{CC} = 4.5 V	-	29	58	-	73	-	87	ns
		$V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$	-	23	49	-	62	-	74	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{THL}	HIGH to LOW	see Fig. 11								
	output transition time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
	transition time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _{TLH}	LOW to HIGH	see Fig. 11								
	output transition time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
	transition time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	CPU, CPD; HIGH or LOW; see Fig. 8								
		V _{CC} = 2.0 V	100	22	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	8	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	6	-	21	-	26	-	ns
		MR HIGH; see Fig. 11								
		V _{CC} = 2.0 V	100	25	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	9	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	7	-	21	-	26	-	ns
		PL LOW; see Fig. 10								
		V _{CC} = 2.0 V	100	19	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	7	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	6	-	21	-	26	-	ns
rec	recovery time	PL to CPU, CPD; see Fig. 10								
		V _{CC} = 2.0 V	50	8	-	65	-	75	-	ns
		V _{CC} = 4.5 V	10	3	-	13	-	15	-	ns
		V _{CC} = 6.0 V	9	2	-	11	-	13	-	ns
		MR to CPU, CPD; see Fig. 11								
		V _{CC} = 2.0 V	50	0	-	65	-	75	-	ns
		V _{CC} = 4.5 V	10	0	-	13	-	15	-	ns
		V _{CC} = 6.0 V	9	0	-	11	-	13	-	ns
t _{su}	set-up time	Dn to PL; see Fig. 12; CPU = CPD = HIGH								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
h	hold time	Dn to PL; see Fig. 12								
		V _{CC} = 2.0 V	0	-14	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-4	-	0		0	-	ns
		CPU to CPD, CPD to CPU; see Fig. 14								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	8	6	-	17	-	20	-	ns

Symbol	Parameter	Conditions		25 °C		-40 °C to +85 °C		-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
f _{max}	maximum	CPU, CPD; see Fig. 8								
	frequency	V _{CC} = 2.0 V	4.0	13.5	-	3.2	-	2.6	-	MHz
		V _{CC} = 4.5 V	20	41	-	16	-	13	-	MHz
		V _{CC} = 6.0 V	24	49	-	19	-	15	-	MHz
C _{PD}	power dissipation capacitance	V_I = GND to V_{CC} ; V_{CC} = 5 V; [2] f_i = 1 MHz	-	24	-	-	-	-	-	pF

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

Table 9. Dynamic characteristics type 74HCT193

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
				Min Typ Max		Min Max		Min Max		
t _{pd}	propagation delay	CPU, CPD to Qn; see Fig. 8 [1]								
		V _{CC} = 4.5 V	-	23	43	-	54	-	65	ns
		CPU to TCU; see Fig. 9								
		V _{CC} = 4.5 V	-	15	27	-	34	-	41	ns
		CPD to TCD; see Fig. 9								
		V _{CC} = 4.5 V	-	15	27	-	34	-	41	ns
		PL to Qn; see Fig. 10								
		V _{CC} = 4.5 V	-	26	46	-	58	-	69	ns
		MR to Qn; see Fig. 11								
		V _{CC} = 4.5 V	-	22	40	-	50	-	60	ns
		Dn to Qn; see Fig. 10								
		V _{CC} = 4.5 V	-	27	46	-	58	-	69	ns
		PL to TCU, PL to TCD; see Fig. 13								
		V _{CC} = 4.5 V	-	31	55	-	69	-	83	ns
		MR to TCU, MR to TCD; see Fig. 13								
		V _{CC} = 4.5 V	-	29	55	-	69	-	83	ns
		Dn to TCU, Dn to TCD; see Fig. 13								
		V _{CC} = 4.5 V	-	32	58	-	73	-	87	ns
t _{THL}	HIGH to LOW	see Fig. 11								
	output transition time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
t _{TLH}	LOW to HIGH	see Fig. 11								
	output transition time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _W	pulse width	CPU, CPD; HIGH or LOW; see Fig. 8								
		V _{CC} = 4.5 V	25	11	-	31	-	38	-	ns
		MR HIGH; see Fig. 11								
		V _{CC} = 4.5 V	20	7	-	25	-	30	-	ns
		PL LOW; see Fig. 10								
		V _{CC} = 4.5 V	20	8	-	25	-	30	-	ns
t _{rec}	recovery time	PL to CPU, CPD; see Fig. 10								
		V _{CC} = 4.5 V	10	2	-	13	-	15	-	ns
		MR to CPU, CPD; see Fig. 11								
		V _{CC} = 4.5 V	10	0	-	13	-	15	-	ns
t _{su}	set-up time	Dn to PL; see Fig. 12; CPU = CPD = HIGH								
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
t _h	hold time	Dn to PL; see Fig. 12								
		V _{CC} = 4.5 V	0	-6	-	0	-	0	-	ns
		CPU to CPD, CPD to CPU; see Fig. 14								
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
f _{max}	maximum	CPU, CPD; see Fig. 8								
	frequency	V _{CC} = 4.5 V	20	43	-	16	-	13	-	MHz
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC} - 1.5 \text{ V};$ [2] $V_{CC} = 5 \text{ V}; f_i = 1 \text{ MHz}$	-	26	-	-	-	-	-	pF

 $\begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PHL} \text{ and } t_{PLH}. \\ [2] & C_{PD} \text{ is used to determine the dynamic power dissipation } (P_D \text{ in } \mu \text{W}): \\ & P_D = C_{PD} \, x \, V_{CC}^{-2} \, x \, f_i \, x \, N + \Sigma (C_L \, x \, V_{CC}^{-2} \, x \, f_o) \text{ where:} \end{array}$

 f_i = input frequency in MHz;

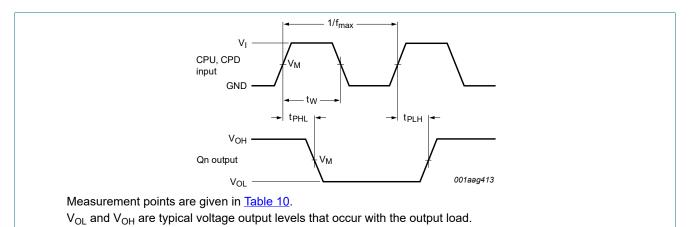
f_o = output frequency in MHz;

C_L = output load capacitance in pF;

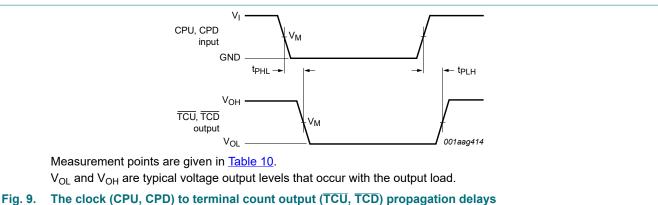
 V_{CC} = supply voltage in V;

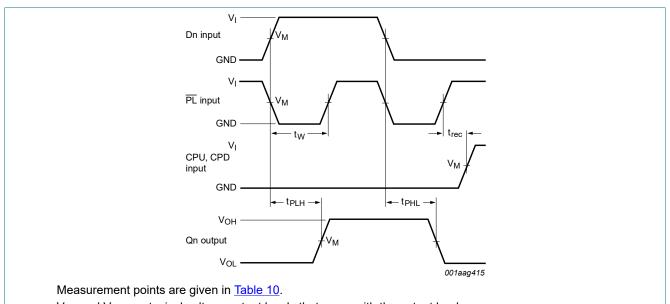
N = number of inputs switching; $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

10.1. Waveforms and test circuit



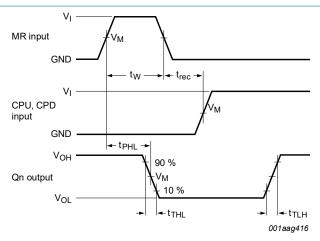
The clock (CPU, CPD) to output (Qn) propagation delays, the clock pulse width, and the maximum clock Fig. 8. pulse frequency





V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

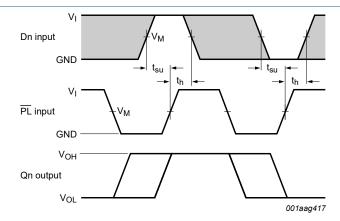
Fig. 10. The parallel load input (PL) and data (Dn) to Qn output propagation delays and PL removal time to clock input (CPU, CPD)



Measurement points are given in Table 10.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 11. The master reset input (MR) pulse width, MR to Qn propagation delays, MR to CPU, CPD removal time and output transition times

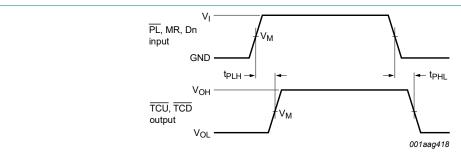


Measurement points are given in <u>Table 10</u>.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 12. The data input (Dn) to parallel load input (PL) set-up and hold times



Measurement points are given in Table 10.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 13. The data input (Dn), parallel load input (PL) and the master reset input (MR) to the terminal count outputs (TCU, TCD) propagation delays

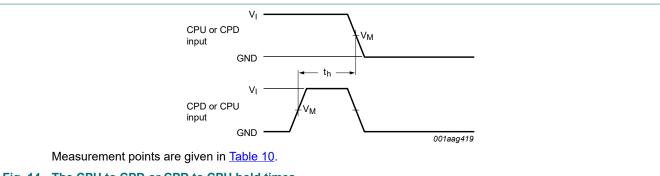
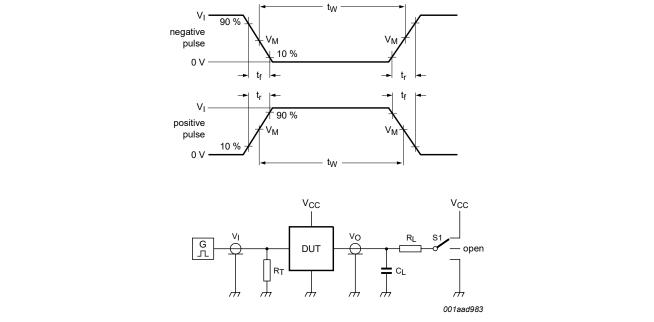


Fig. 14. The CPU to CPD or CPD to CPU hold times

Table 10. Measurement points

Туре	Input	Output	
	V _M	V _I	V _M
74HC193	0.5 × V _{CC}	GND to V _{CC}	0.5 × V _{CC}
74HCT193	1.3 V	GND to 3 V	1.3 V



Test data is given in Table 11.

Definitions test circuit:

 R_{T} = Termination resistance should be equal to output impedance Z_{o} of the pulse generator

C_L = Load capacitance including jig and probe capacitance

R_L = Load resistor

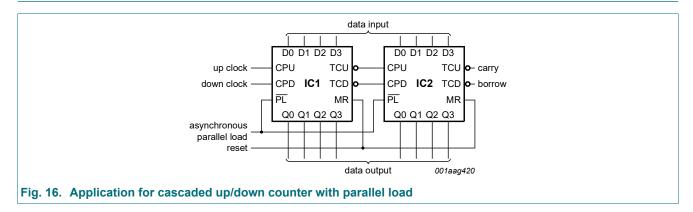
S1 = Test selection switch

Fig. 15. Test circuit for measuring switching times

Table 11. Test data

	Туре	Input		Load	S1 position			
		VI	t _r , t _f	CL	R_L	t _{PHL} , t _{PLH}		
	74HC193	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open		
	74HCT193	3 V	6 ns	15 pF, 50 pF	1 kΩ	open		

11. Application information



12. Package outline

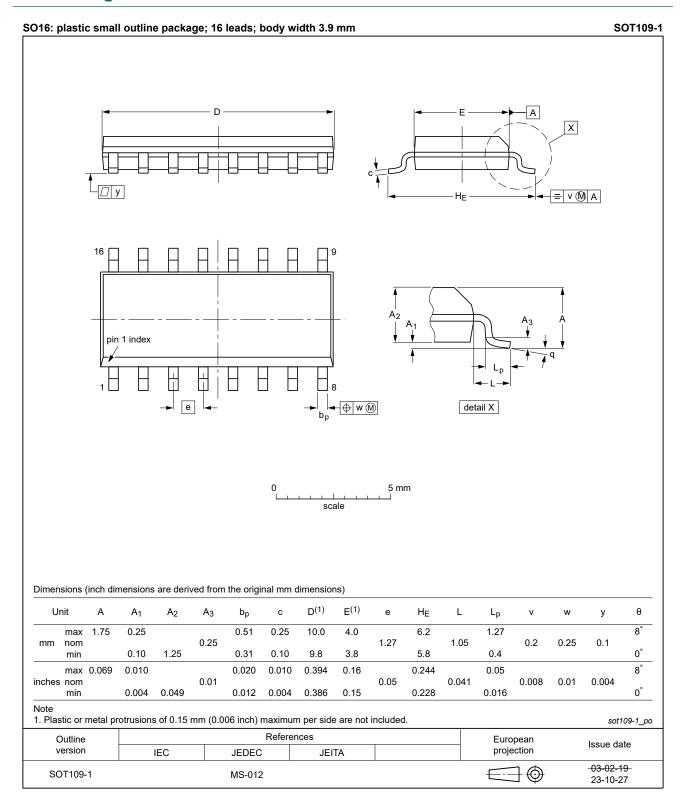


Fig. 17. Package outline SOT109-1 (SO16)

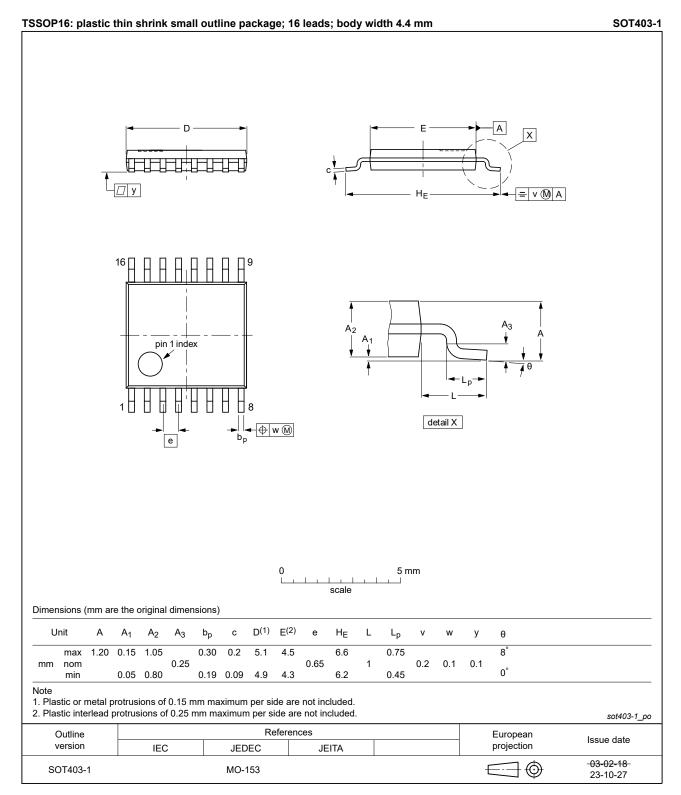


Fig. 18. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC_HCT193 v.8	20240314	Product data sheet	-	74HC_HCT193 v.7		
Modifications:	 Fig. 17, Fig. 18: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153. Section 2: ESD specification updated according to the latest JEDEC standard. 					
74HC_HCT193 v.7	20210910	Product data sheet	-	74HC_HCT193 v.6		
Modifications:	Section 2 updaType number 7	ated. 74HCT193DB (SOT338-1/SSC	P16) removed.			
74HC_HCT193 v.6	20210205	Product data sheet	-	74HC_HCT193 v.5		
Modifications:		Type Hamber 7-H10130BB (CC1300-H3001-10)Tellioved.				
74HC_HCT193 v.5	20160129	Product data sheet	-	74HC_HCT193 v.4		
Modifications:	Type numbers	74HC193N and 74HCT193N	(SOT38-4) removed			
74HC_HCT193 v.4	20130624	Product data sheet	-	74HC_HCT193 v.3		
Modifications:	General descr	iption updated.				
74HC_HCT193 v.3	20070523	Product data sheet	-	74HC_HCT193_CNV v.2		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Family specification included. 					
74HC_HCT193_CNV v.2	19970828	Product specification	-	-		

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition		
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.		
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.		
Product [short] data sheet	Production	This document contains the product specification.		

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